



PC Board Layout
Component Side Shown

NOTES:

MATERIAL :

- 1.HOUSING MATERIAL :GLASS FILLED POLYESTER UL94V-0.
- 2.CONTACT MATERIAL :PHOSPHOR BRONZE φ0.46mm.
- 3.PLATING :GOLD PLATING OVER NICKEL.

ELECTRICAL:

- 1.VOLTAGE RATING :125 VAC RMS.
- 2.CURRENT RATING :1.5 AMP.
- 3.CONTACT RESISTANCE :30 MILLIOHMS MAX.
- 4.INSULATION RESISTANCE :500 MEGOHMS MIN @ 500V DC .
- 5.DIELECTRIC WITHSTANDING RESISTANCE :1000V AC RMS 50Hz. 1MIN.

MECHANICAL:

- 1.DURRABILITY :750 CYCLES MIN.
- 2.PCB RETENTION PRE-SOLDER :1 LB MIN.

ENVIRONMENTAL:

- 1. STORAGE : -40°C~+85°C
- 2. OPERATION : 0°C TO 70°C.

DETACHED LISTS	MM ← INCH →	DFTD: SHB	DATE: 2007.05.03	Coorle Technology	
	TOLERANCES EXCEPT AS NOTED	CHKD: LAMB	DATE: 2007.05.03		
	MM .8 ± 0.15 * .00 ± 0.075 * .000 ± 0.05 *	MFP:	DATE:	DRAWING NO. TES981008 /PART NO.	
	ANGLES ± 0.5	APPVL:	DATE:		
 THIRD ANGLE PROJECTION	MATERIAL :	QTY :	DO NOT SCALE DRAWING		
	FINISH :	SCALE :			SHEET X OF Y